

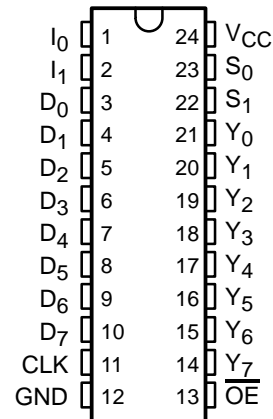
CY29FCT520T

MULTILEVEL PIPELINE REGISTER WITH 3-STATE OUTPUTS

SCCS011C – MAY 1994 – REVISED NOVEMBER 2001

- Function, Pinout, and Drive Compatible With FCT, F Logic, and AM29520
- Reduced V_{OH} (Typically = 3.3 V) Version of Equivalent FCT Functions
- Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics
- I_{off} Supports Partial-Power-Down Mode Operation
- Matched Rise and Fall Times
- Fully Compatible With TTL Input and Output Logic Levels
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- Single- and Dual-Pipeline Operation Modes
- Multiplexed Data Inputs and Outputs
- CY29FCT520T
 - 64-mA Output Sink Current
 - 32-mA Output Source Current
- CY29FCT520ATDMB, CY29FCT520BTDMB
 - 32-mA Output Sink Current
 - 12-mA Output Source Current
- 3-State Outputs

D, P, OR SO PACKAGE
(TOP VIEW)



description

The CY29FCT520T is a multilevel 8-bit-wide pipeline register. The device consists of four registers, A1, A2, B1, and B2, which are configured by the instruction inputs I_0 , I_1 as a single four-level pipeline or as two two-level pipelines. The contents of any register can be read at the multiplexed output at any time by using the multiplex-selection controls (S_0 and S_1).

The pipeline registers are positive-edge triggered, and data is shifted by the rising edge of the clock input. Instruction $I = 0$ selects the four-level pipeline mode. Instruction $I = 1$ selects the two-level B pipeline, while $I = 2$ selects the two-level A pipeline. $I = 3$ is the hold instruction; no shifting is performed by the clock in this mode.

In the two-level operation mode, data is shifted from level 1 to level 2 and new data is loaded into level 1.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



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**TEXAS
INSTRUMENTS**

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PIPELINE INSTRUCTION TABLE

I = 0		I = 1		I = 2		I = 3	
I ₁ = 0	I ₀ = 0	I ₁ = 0	I ₀ = 1	I ₁ = 1	I ₀ = 0	I ₁ = 1	I ₀ = 1
Single four-level		Dual two-level		Hold			

ORDERING INFORMATION

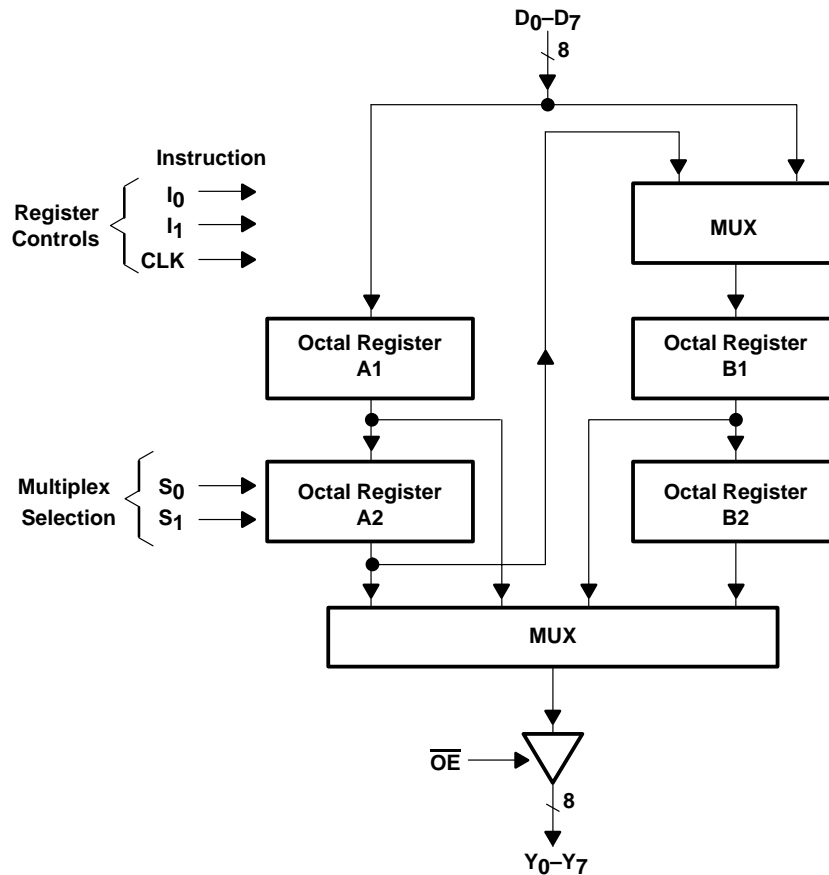
T _A	PACKAGE†		SPEED (ns)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – SO	Tube	6.0	CY29FCT520CTSOC	29FCT520C
		Tape and reel	6.0	CY29FCT520CTSOCT	
	SOIC – SO	Tube	7.5	CY29FCT520BTSOC	29FCT520B
		Tape and reel	7.5	CY29FCT520BTSOCT	
	DIP – P	Tube	14.0	CY29FCT520ATPC	CY29FCT520ATPC
	SOIC – SO	Tube	14.0	CY29FCT520ATSOC	29FCT520A
		Tape and reel	14.0	CY29FCT520ATSOCT	
–55°C to 125°C	CDIP – D	Tube	8.0	5962-9220504MLA (CY29FCT520BTDMB)	
		Tube	16.0	5962-9220502MLA (CY29FCT520ATDMB)	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

INPUTS		OUTPUT
S ₁	S ₀	
1	1	A1
1	0	A2
0	1	B1
0	0	B2

logic diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range to ground potential	–0.5 V to 7 V
DC input voltage range	–0.5 V to 7 V
DC output voltage range	–0.5 V to 7 V
DC output current (maximum sink current/pin)	120 mA
Package thermal impedance, θ_{JA} (see Note 1): P package	67°C/W
(see Note 2): SO package	46°C/W
Ambient temperature range with power applied, T_A	–65°C to 135°C
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The package thermal impedance is calculated in accordance with JESD 51-3.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 3)

		CY29FCT520ATDMB CY29FCT520BTDMB			CY29FCT520T			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
I _{OH}	High-level output current			–12			–32	mA
I _{OL}	Low-level output current			32			64	mA
T _A	Operating free-air temperature	–55		125	–40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		CY29FCT520ATDMB CY29FCT520BTDMB			CY29FCT520T			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V _{IK}	V _{CC} = 4.5 V, I _{IN} = –18 mA			–0.7	–1.2				V
	V _{CC} = 4.75 V, I _{IN} = –18 mA						–0.7	–1.2	
V _{OH}	V _{CC} = 4.5 V, I _{OH} = –12 mA		2.4	3.3					V
	V _{CC} = 4.75 V	I _{OH} = –15 mA				2.4	3.3		
		I _{OH} = –32 mA				2			
V _{OL}	V _{CC} = 4.5 V, I _{OL} = 32 mA			0.3	0.55				V
	V _{CC} = 4.75 V, I _{OL} = 64 mA						0.3	0.55	
V _{hys}	All inputs			0.2			0.2		V
I _I	V _{CC} = 5.5 V, V _{IN} = V _{CC}				5				μA
	V _{CC} = 5.25 V, V _{IN} = V _{CC}							5	
I _{IH}	V _{CC} = 5.5 V, V _{IN} = 2.7 V				±1				μA
	V _{CC} = 5.25 V, V _{IN} = 2.7 V							±1	
I _{IL}	V _{CC} = 5.5 V, V _{IN} = 0.5 V				±1				μA
	V _{CC} = 5.25 V, V _{IN} = 0.5 V							±1	
I _{off}	V _{CC} = 0 V, V _{OUT} = 4.5 V				±1			±1	μA
I _{OS} ‡	V _{CC} = 5.5 V, V _{OUT} = 0 V		–60	–120	–225				mA
	V _{CC} = 5.25 V, V _{OUT} = 0 V					–60	–120	–225	
I _{OZH}	V _{CC} = 5.5 V, V _{IN} = 2.7 V				10				μA
	V _{CC} = 5.25 V, V _{IN} = 2.7 V							10	
I _{OZL}	V _{CC} = 5.5 V, V _{IN} = 0.5 V				–10				μA
	V _{CC} = 5.25 V, V _{IN} = 0.5 V							–10	
I _{CC}	V _{CC} = 5.5 V, V _{IN} ≤ 0.2 V, V _{IN} ≥ V _{CC} – 0.2 V			0.1	0.2				mA
	V _{CC} = 5.25 V, V _{IN} ≤ 0.2 V, V _{IN} ≥ V _{CC} – 0.2 V						0.1	0.2	
ΔI _{CC}	V _{CC} = 5.5 V, V _{IN} = 3.4 V§, f ₁ = 0, Outputs open			0.5	2				mA
	V _{CC} = 5.25 V, V _{IN} = 3.4 V§, f ₁ = 0, Outputs open						0.5	2	

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

§ Per TTL-driven input (V_{IN} = 3.4 V); all other inputs at V_{CC} or GND



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS			CY29FCT520ATDMB CY29FCT520BTDMB			CY29FCT520T			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
I _{CCD} ¶	V _{CC} = 5.5 V, Outputs open, One bit switching at 50% duty cycle, \overline{OE} = GND, V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} − 0.2 V				0.06	0.12				mA/ MHz
	V _{CC} = 5.25 V, Outputs open, One bit switching at 50% duty cycle, \overline{OE} = GND, V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} − 0.2 V							0.06	0.12	
I _C [#]	V _{CC} = 5.5 V, Outputs open, f ₀ = 10 MHz, OE = GND	One bit switching at f ₁ = 5 MHz at 50% duty cycle	V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} − 0.2 V		0.7	1.4				mA
			V _{IN} = 3.4 V or GND		1.2	3.4				
		Eight bits switching at f ₁ = 5 MHz at 50% duty cycle	V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} − 0.2 V		2.8	5.6				
			V _{IN} = 3.4 V or GND		5.1	14.3				
	V _{CC} = 5.25 V, Outputs open, f ₀ = 10 MHz, OE = GND	One bit switching at f ₁ = 5 MHz at 50% duty cycle	V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} − 0.2 V					0.7	1.4	
			V _{IN} = 3.4 V or GND					1.2	3.4	
		Eight bits switching at f ₁ = 5 MHz at 50% duty cycle	V _{IN} ≤ 0.2 V or V _{IN} ≥ V _{CC} − 0.2 V					2.8	5.6	
			V _{IN} = 3.4 V or GND					5.1	14.3	
C _i					5	10		5	10	pF
C _O					9	12		9	12	pF

† Typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

¶ This parameter is derived for use in total power-supply calculations.

$I_C = I_{CC} + \Delta I_{CC} \times D_H \times N_T + I_{CCD} (f_0/2 + f_1 \times N_1)$

Where:

I_C = Total supply current

I_{CC} = Power-supply current with CMOS input levels

ΔI_{CC} = Power-supply current for a TTL high input ($V_{IN} = 3.4$ V)

D_H = Duty cycle for TTL inputs high

N_T = Number of TTL inputs at D_H

I_{CCD} = Dynamic current caused by an input transition pair (HLH or LHL)

f_0 = Clock frequency for registered devices, otherwise zero

f_1 = Input signal frequency

N_1 = Number of inputs changing at f_1

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the I_{CC} formula.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		CY29FCT520ATDMB		CY29FCT520BTDMB		UNIT
		MIN	MAX	MIN	MAX	
t_w	Pulse duration, CLK high or low	8		6		ns
t_{su}	Setup time, before CLK \uparrow	Data	6	2.8		ns
		I	6	4.5		
t_h	Hold time, after CLK \uparrow	Data	2	2		ns
		I	2	2		

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		CY29FCT520AT		CY29FCT520BT		CY29FCT520CT		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t_w	Pulse duration, CLK high or low	7		5.5		5.5		ns
t_{su}	Setup time, before CLK \uparrow	Data	5	2.5		2.5		ns
		I	5	4		4		
t_h	Hold time, after CLK \uparrow	Data	2	2		2		ns
		I	2	2		2		

switching characteristics over operating free-air temperature range (see Figure 1)

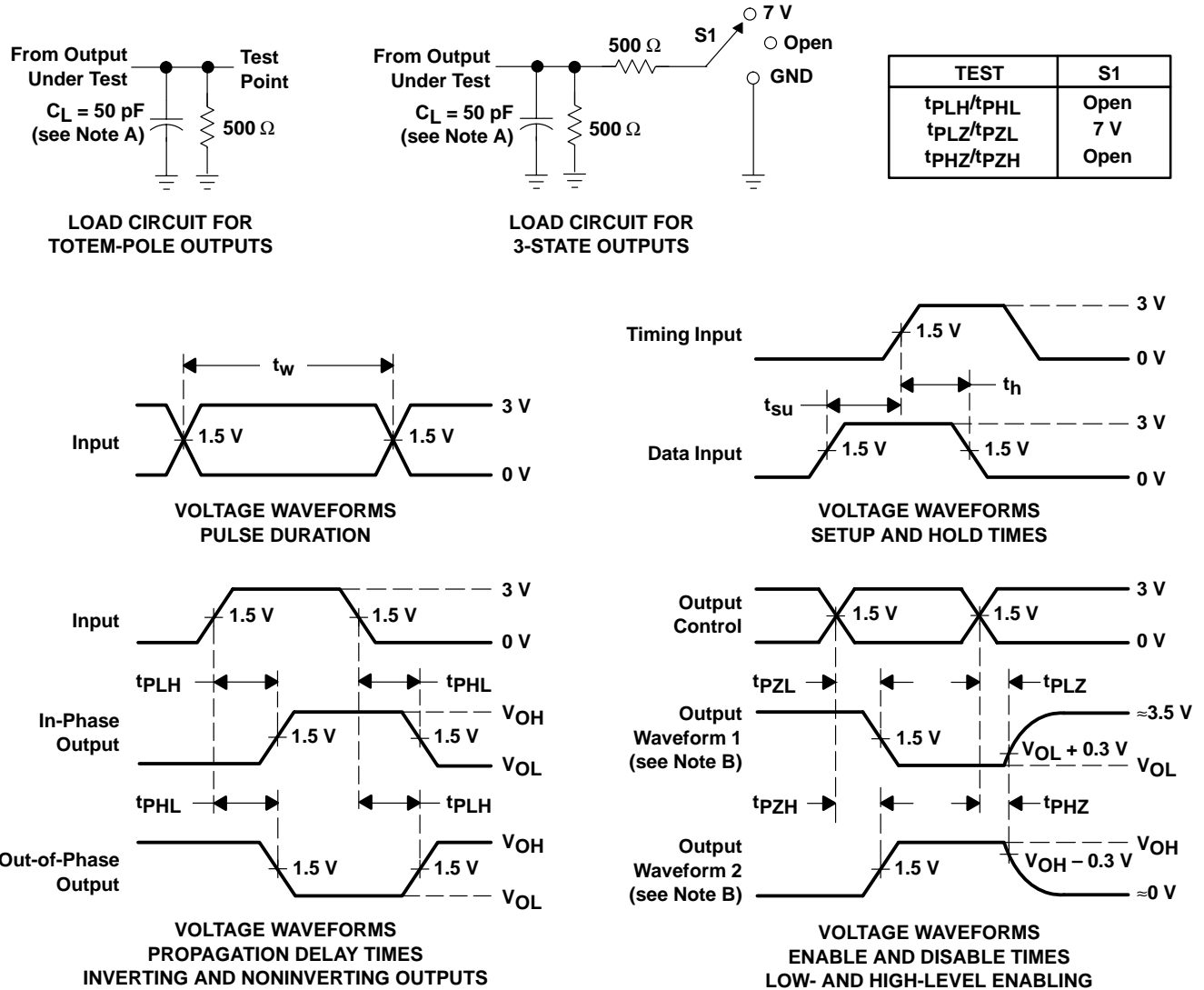
PARAMETER	FROM (INPUT)	TO (OUTPUT)	CY29FCT520ATDMB		CY29FCT520BTDMB		UNIT
			MIN	MAX	MIN	MAX	
t_{PLH}	CLK	Y	2	16	2	8	ns
t_{PHL}			2	16	2	8	
t_{PLH}	S_0 or S_1	Y	2	15	2	8	ns
t_{PHL}			2	15	2	8	
t_{PHZ}	\overline{OE}	Y	1.5	13	1.5	7.5	ns
t_{PLZ}			1.5	13	1.5	7.5	
t_{PZH}	\overline{OE}	Y	1.5	16	1.5	8	ns
t_{PZL}			1.5	16	1.5	8	

switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CY29FCT520AT		CY29FCT520BT		CY29FCT520CT		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	CLK	Y	2	14	2	7.5	2	6	ns
t_{PHL}			2	14	2	7.5	2	6	
t_{PLH}	S_0 or S_1	Y	2	13	2	7.5	2	6	ns
t_{PHL}			2	13	2	7.5	2	6	
t_{PHZ}	\overline{OE}	Y	1.5	12	1.5	7	1.5	6	ns
t_{PLZ}			1.5	12	1.5	7	1.5	6	
t_{PZH}	\overline{OE}	Y	1.5	15	1.5	7.5	1.5	6	ns
t_{PZL}			1.5	15	1.5	7.5	1.5	6	



PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265